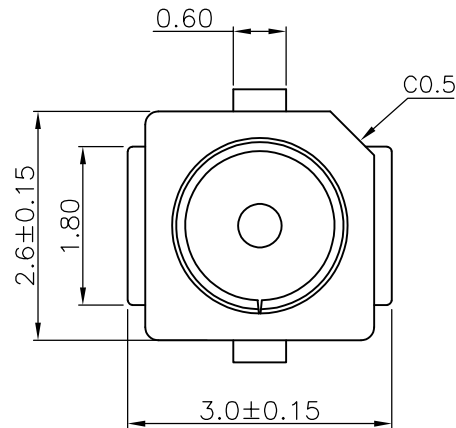
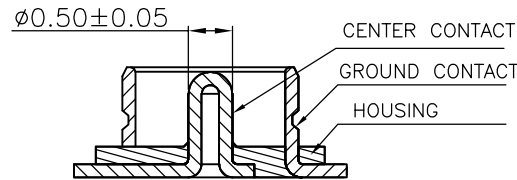
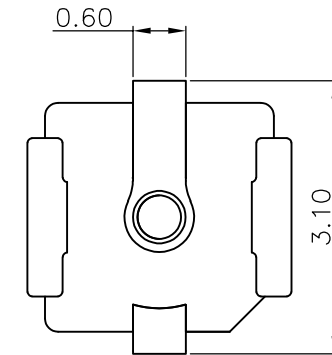
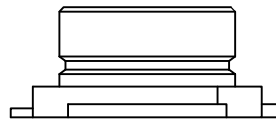
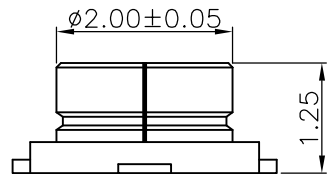
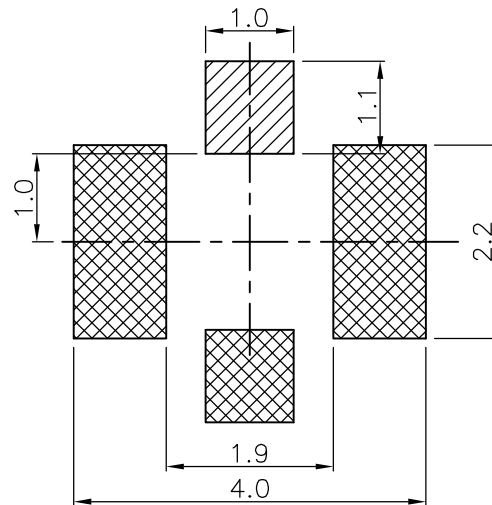
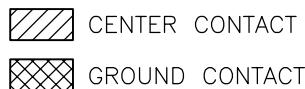




RoHS
Compliant

REV.	ZONE	DESCRIPTION	DESIGN	DATE
B		NEW		

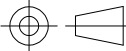


RECOMMENDED PCB LAYOUT
(TOLERANCE:±0.05)

NOTE:

- MATERIAL:
 - HOUSING: THERMOPLASTIC,UL94V-0, COLOR:NATURE.
 - CENTER CONTACT : COPPER ALLOY.
 - GROUND CONTACT: COPPER ALLOY.
- FINISH:
 - CENTER CONTACT:GOLD PLATING.
50u" MIN. NICKEL UNDERPLATING.
 - GROUND CONTACT GOLD PLATING;
50u" MIN. NICKEL UNDERPLATING OVERALL.
- PART NUMBER DESCRIPTION:

PART NO.	DESCRIPTION
9181-000040	GROUND CONTACT GOLD PLATING
- APPLIED TO IR SOLDERING PROCESS
- COPLANARITY: 0.10mm MAX.

X. ±0.50	X.° ± 2°	UNITS mm	广东创粤科技有限公司				
.X ±0.30	.X° ± 1°	MAT'L <div></div>	TITLE: RF 一代天线座 本色塑胶 4焊脚 金flash				
.XX ±0.10	.XX° ± 0.5°						
.XXX ± 0.05		FINISH <div></div> Q'TY <div></div>	APPD:	DWG NO.:			
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			DR:		SCALE	SHEET	REV.
					1/1	1/1	A1